

Global Semiconductor Advanced Packaging Market Growth (Status and Outlook) 2025-2031

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Abstracts

According to this study, the global Semiconductor Advanced Packaging market size will reach US\$ 29750 million by 2031.

Advanced packaging is a general grouping of a variety of distinct techniques, including 2.5D, 3D-IC, fan-out wafer-level packaging and system-in-package, etc.

Following a strong growth of 26.2 percent in the year 2021, WSTS revised it down to a single digit growth for the worldwide semiconductor market in 2022 with a total size of US\$580 billion, up 4.4 percent. WSTS lowered growth estimation as inflation rises and end markets seeing weaker demand, especially those exposed to consumer spending. While some major categories are still double-digit year-over-year growth in 2022, led by Analog with 20.8 percent, Sensors with 16.3 percent, and Logic with 14.5 percent growth. Memory declined with 12.6 percent year over year. In 2022, all geographical regions showed double-digit growth except Asia Pacific. The largest region, Asia Pacific, declined 2.0 percent. Sales in the Americas were US\$142.1 billion, up 17.0% year-on-year, sales in Europe were US\$53.8 billion, up 12.6% year-on-year, and sales in Japan were US\$48.1 billion, up 10.0% year-on-year. However, sales in the largest Asia-Pacific region were US\$336.2 billion, down 2.0% year-on-year.

LPI (LP Information)' newest research report, the "Semiconductor Advanced Packaging Industry Forecast" looks at past sales and reviews total world Semiconductor Advanced Packaging sales in 2024, providing a comprehensive analysis by region and market sector of projected Semiconductor Advanced Packaging sales for 2025 through 2031. With Semiconductor Advanced Packaging sales broken down by region, market sector and sub-sector, this report provides a detailed analysis in US\$ millions of the world Semiconductor Advanced Packaging industry.

This Insight Report provides a comprehensive analysis of the global Semiconductor Advanced Packaging landscape and highlights key trends related to product segmentation, company formation, revenue, and market share, latest development, and M&A activity. This report also analyses the strategies of leading global companies with a focus on Semiconductor Advanced Packaging portfolios and capabilities, market entry strategies, market positions, and geographic footprints, to better understand these firms' unique position in an accelerating global Semiconductor Advanced Packaging market.

This Insight Report evaluates the key market trends, drivers, and affecting factors shaping the global outlook for Semiconductor Advanced Packaging and breaks down the forecast by Type, by Application, geography, and market size to highlight emerging pockets of opportunity. With a transparent methodology based on hundreds of bottom-up qualitative and quantitative market inputs, this study forecast offers a highly nuanced view of the current state and future trajectory in the global Semiconductor Advanced Packaging.

This report presents a comprehensive overview, market shares, and growth opportunities of Semiconductor Advanced Packaging market by product type, application, key players and key regions and countries.

Segmentation by Type:

Fan-Out Wafer-Level Packaging (FO WLP)

Fan-In Wafer-Level Packaging (FI WLP)

Flip Chip (FC)

2.5D/3D

Segmentation by Application:

Telecommunications

Automotive

Aerospace and Defense

Medical Devices

Consumer Electronics

Other

This report also splits the market by region:

Americas

United States

Canada

Mexico

Brazil

APAC

China

Japan

Korea

Southeast Asia

India

Australia

Europe

Germany

France

UK

Italy

Russia

Middle East & Africa

Egypt

South Africa

Israel

Turkey

GCC Countries

The below companies that are profiled have been selected based on inputs gathered from primary experts and analyzing the company's coverage, product portfolio, its market penetration.

Advanced Semiconductor Engineering (ASE)

Amkor Technology

Samsung

TSMC (Taiwan Semiconductor Manufacturing Company)

China Wafer Level CSP

ChipMOS Technologies

FlipChip International

HANA Micron

Interconnect Systems (Molex)

Jiangsu Changjiang Electronics Technology (JCET)

King Yuan Electronics

Tongfu Microelectronics

Nepes

Powertech Technology (PTI)

Signetics

Tianshui Huatian

Veeco/CNT

UTAC Group

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